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MIPI to Bluetooth LE: Leveraging Mobile Technology for Wireless IoT Applications

22-23 SEPTEMBER 2020

MIPI ALLIANCE DEVELOPERS CONFERENCE

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MIPI and IoT Ecosystems at a Glance



- 1. MIPI Standardization in mobile has made many new mobile influenced products possible
- 2. Many of these new products "retro-fit" MIPI sensors from other more mature markets
- 3. Many of these products are wireless



FPGA's influence on MIPI Adoption

- FPGA's have historically been a critical part of MIPI interface adoption
 - Interface and bridging
 - Mobile multi-camera, display replacement, VR, Drone, Automotive, Industrial
 - Early interface and link layer adoption
 - Prototyping
- FPGA's have dramatically changed over the last 10 years

– Power: Sub mW

Cost: Sub \$1

Size: Sub 4mm²

• FPGA's provide a great path to implement differentiated, non-native SoC features. Still dependent on the SoC; not a standalone solution.



New Feature Driven FPGAs

- Extended memory FPGAs
 - 4-8MB extended RAM
 - Video frame buffer
 - Audio spectrogram buffer
 - Instrumentation data buffering
- Security FPGAs
 - PUF for unclonable system firmware
 - Asynchronous Key Pairs
- SoC FPGAs
 - FPGA + Microprocessor
 - FPGA + Bluetooth + Microprocessor

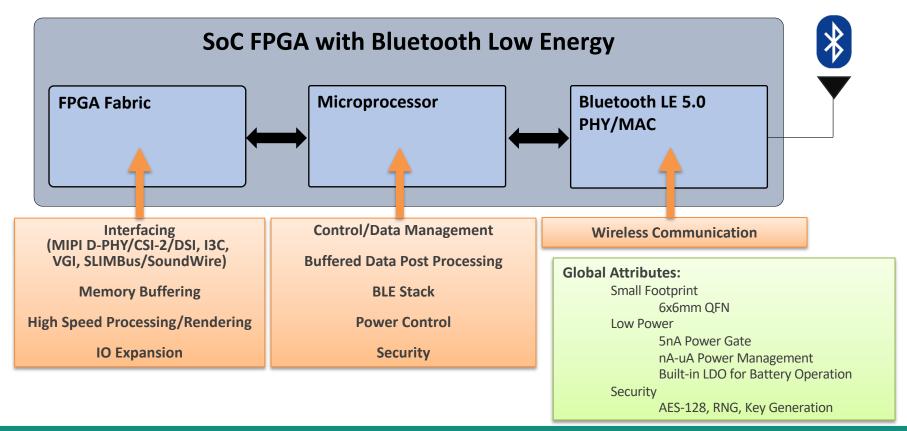
FPGA's can process high-throughput use cases

FPGA's often used for 'first on' and 'always listening' applications since a gate array does not need to be continually clocked

Microprocessor can focus on control, monitoring and post processing while FPGA can handle throughput/time intensive computations.

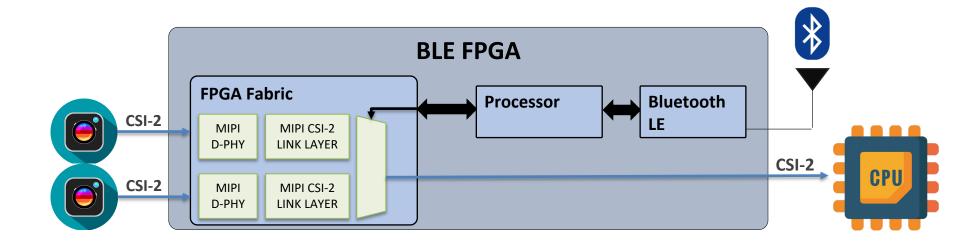


Bluetooth LE Enabled FPGA Concept



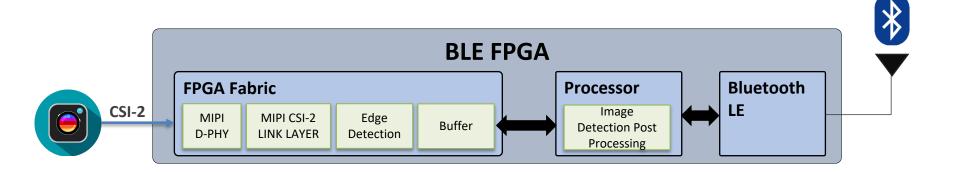


MIPI CSI-2sM Camera Application Example



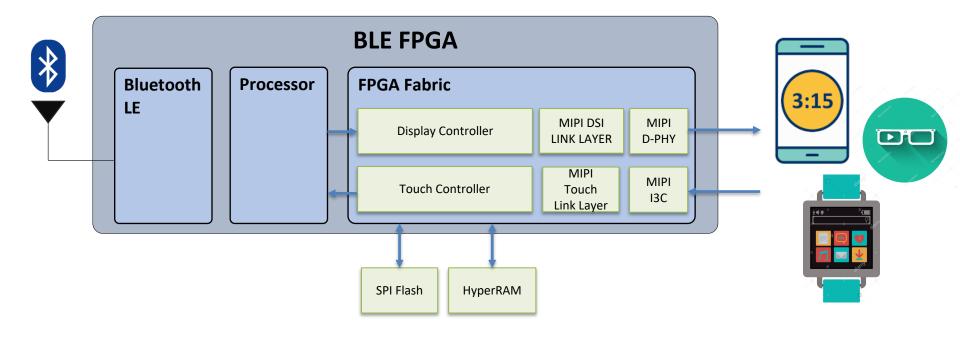


MIPI CSI-2 Camera Application Example



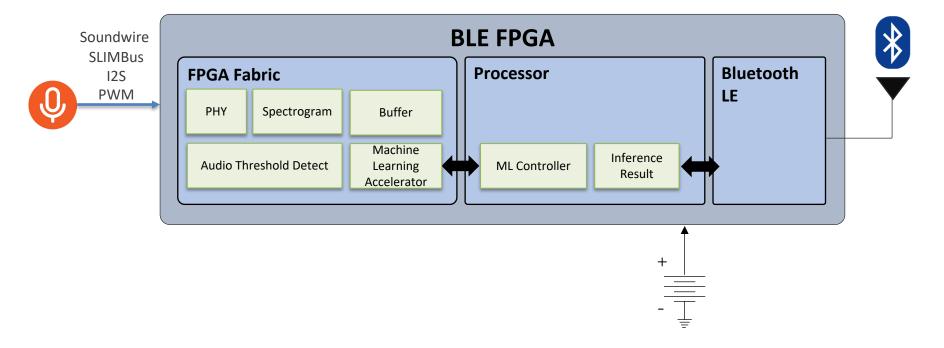


MIPI DSI[™] and Touch Display Application Examples



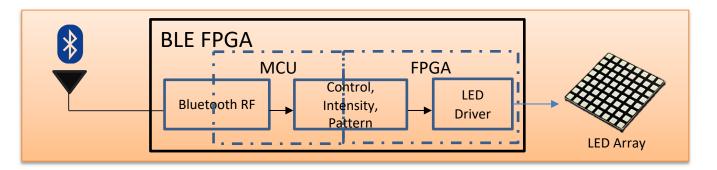


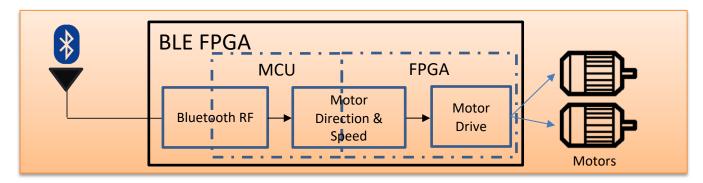
MIPI SoundWire/SLIMBus Audio Application Example





Other Interesting Use Cases







Summary – FPGAs Extend MIPI Related Use Cases

- Programmability of Mobile FPGAs enable new uses of MIPI sensors providing differentiated and innovative end products
 - High Speed Interfaces (Cameras, Displays)
 - Compute Intensive Cases (Machine Learning, FFT/Spectrogram, Computer Vision)
 - Data Buffering (Video Frame Buffering, Audio Buffering, Instrumentation and Test Equipment)
 - High IO Count (Camera Aggregation, Audio Beam Forming, Sensor Hub)
 - Always-On, Always Listening and Fast Wake-Up Cases
- SoC integration of MCU, FPGA and other key features such as Bluetooth Low Energy further extend usage of MIPI sensors



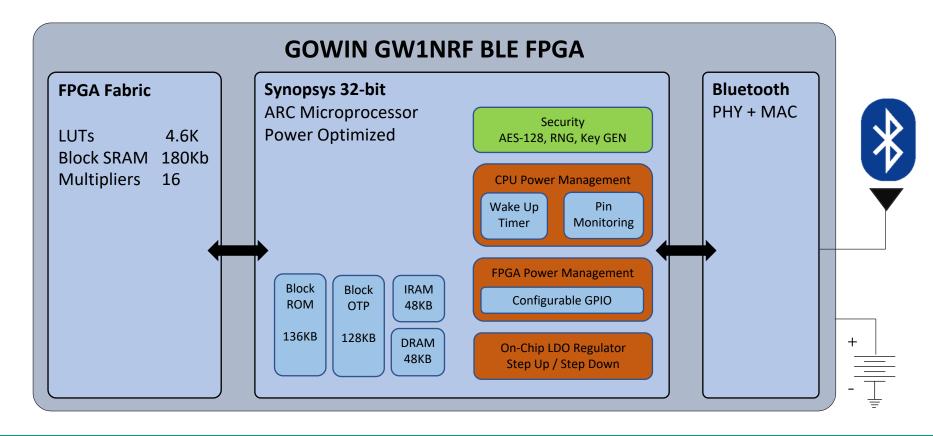
GOWIN enables MIPI by Manufacturing Unique and Differentiated FPGAs

		GOWIN FPGA Device Family				
		LittleBee			Arora	
		Flash-Based FPGA		<u>FPGA</u>	SRAM-Based FPGA	
		GW1N* 1-10K			GW2A* 20-55K	
	Lut	Logic Element Density		Density	Logic Element Density	
Product Features	Ultra Low Power Device Power Management	*Z				
	Hard MCU ARM Cortex M3 ARC EM4	*\$	*SR	*SE *SER		
	Extended Memory On-Chip SRAM / Flash	*R	SK		*R	
	Security SRAM PUF Root-of- Trust					
	Bluetooth Low Energy RF Transceiver	*RF				

Product Series	FPGA Density (LUTs)	LittleBee Features	Arora Features
<u>GW1N</u>	1K, 4K, 9K	Flash-Based FPGA	
<u>GW1NZ</u>	1K	Ultra-Low Power	
<u>GW1NS</u>	2K, 4K	Embedded Hardcore MCU	
<u>GW1NR</u>	4K, 9K	Extended Memory	
<u>GW1NSR</u>	2K, 4K	MCU + Memory	N/A
<u>GW1NSE</u>	2K, 4K	MCU + Security	
<u>GW1NSER</u>	2K. 4K	MCU + Security + Memory	
<u>GW1NRF</u>	4K	MCU + Security + RF Transceiver	
<u>GW2A</u>	20K, 55K	N/A	RAM-Based FPGA
<u>GW2AR</u>	20K		Extended Memory



GOWIN GW1NRF Bluetooth LE 5.0 Enabled FPGA







GOWIN GW1NRF Bluetooth LE FPGA Product Page:

https://www.gowinsemi.com/en/product/detail/2/

GOWIN GW1NRF Bluetooth LE FPGA Development Kit Page:

https://www.gowinsemi.com/en/support/devkits_detail/19/

Other Inquiries:

info@gowinsemi.com





THANK YOU

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